# Onsemi

## Silicon Carbide (SiC) MOSFET – 80 mohm, 1200 V, M1, TO-247-3L NTHL080N120SC1

#### Features

- Typ.  $R_{DS(on)} = 80 \text{ m}\Omega$
- Ultra Low Gate Charge (typ. Q<sub>G(tot)</sub> = 56 nC)
- Low Effective Output Capacitance (typ. Coss = 80 pF)
- 100% UIL Tested
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb-Free 2LI (on second level interconnection)

#### **Typical Applications**

- UPS
- DC-DC Converter
- Boost Inverter

#### MAXIMUM RATINGS (T<sub>.1</sub> = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V <sub>DSS</sub>	1200	V	
Gate-to-Source Voltage	Gate-to-Source Voltage		V <sub>GS</sub>	-15/+25	V
Recommended Opera- tion Values of Gate-to- Source Voltage	T <sub>C</sub> < 175°C		V <sub>GSop</sub>	-5/+20	V
Continuous Drain Current $R_{\theta JC}$	Steady State	$T_{\rm C} = 25^{\circ}{\rm C}$	Ι <sub>D</sub>	31	A
Power Dissipation $R_{\theta JC}$			PD	178	W
Continuous Drain Current $R_{\theta JC}$	Steady State	T <sub>C</sub> = 100°C	Ι <sub>D</sub>	22	A
Power Dissipation $R_{\theta JC}$			PD	89	W
Pulsed Drain Current (Note 2)	$T_A = 25^{\circ}C$		I <sub>DM</sub>	DM 132	
Single Pulse Surge Drain Current Capability	$\begin{array}{l} T_{A} = 25^\circC,  t_{p} = 10 \; \mu s, \\ R_{G} = 4.7 \; \Omega \end{array}$		I <sub>DSC</sub>	132	A
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	–55 to +175	°C	
Source Current (Body Diode)		ls	18	А	
Single Pulse Drain-to-Source Avalanche Energy ( $I_{L(pk)}$ = 18.5 A, L = 1 mH) (Note 3)		E <sub>AS</sub>	171	mJ	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

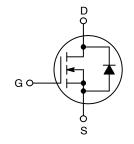
Parameter	Symbol	Value	Unit
Junction-to-Case (Note 1)	$R_{\theta JC}$	0.84	°C/W
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	40	°C/W

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Repetitive rating, limited by max junction temperature. 3.  $E_{AS}$  of 171 mJ is based on starting T<sub>J</sub> = 25°C; L = 1 mH, I<sub>AS</sub> = 18.5 A,  $V_{DD} = 120 \text{ V}, \text{ V}_{GS} = 18 \text{ V}.$ 

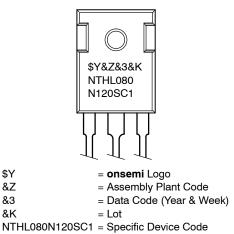
V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX
1200 V	110 mΩ @ 20 V	31 A

#### **N-CHANNEL MOSFET**





#### MARKING DIAGRAM



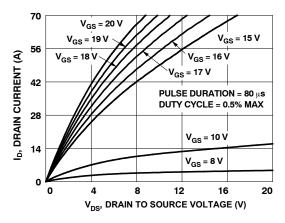
#### **ORDERING INFORMATION**

Device	Package	Shipping		
NTHL080N120SC1	TO247-3L	30 Units / Tube		

#### **ELECTRICAL CHARACTERISTICS**

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	1200	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>	$I_D = 1$ mA, referenced to $25^{\circ}C$	-	700	-	mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = 1200 V, $T_J$ = 25 $^\circ C$	-	_	100	μA
		$V_{GS}$ = 0 V, $V_{DS}$ = 1200 V, $T_{J}$ = 175°C	-	-	1	mA
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{GS}$ = +25/-15 V, $V_{DS}$ = 0 V	-	_	±1	μA
ON CHARACTERISTICS						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{GS} = V_{DS}, I_D = 5 \text{ mA}$	1.8	2.7	4.3	V
Recommended Gate Voltage	V <sub>GOP</sub>		-5	-	+20	V
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	$V_{GS}$ = 20 V, $I_D$ = 20 A, $T_J$ = 25 °C	-	80	110	mΩ
		$V_{GS}$ = 20 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 150°C	-	114	-	
Forward Transconductance	9fs	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 20 A	-	13	-	S
CHARGES, CAPACITANCES & GATE	RESISTANCE					
Input Capacitance	C <sub>ISS</sub>	$V_{GS}$ = 0 V, f = 1 MHz, $V_{DS}$ = 800 V	-	1112	-	pF
Output Capacitance	C <sub>OSS</sub>		-	80	-	
Reverse Transfer Capacitance	C <sub>RSS</sub>		-	6.5	-	
Total Gate Charge	Q <sub>G(tot)</sub>	$V_{GS} = -5/20$ V, $V_{DS} = 600$ V, $I_D = 20$ A	-	56	-	nC
Gate-to-Source Charge	Q <sub>GS</sub>	-	-	11	-	
Gate-to-Drain Charge	Q <sub>GD</sub>		-	12	-	
Gate Resistance	R <sub>G</sub>	f = 1 MHz	-	1.7	-	Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{GS} = -5/20 \text{ V}, \text{ V}_{DS} = 800 \text{ V},$	-	13	-	ns
Rise Time	t <sub>r</sub>	I <sub>D</sub> = 20 A, R <sub>G</sub> = 4.7 Ω, Inductive Load	-	20	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		-	22	-	
Fall Time	t <sub>f</sub>		-	10	-	
Turn-On Switching Loss	E <sub>ON</sub>		-	258	-	μJ
Turn-Off Switching Loss	E <sub>OFF</sub>		-	52	-	
Total Switching Loss	E <sub>TOT</sub>		-	311	-	
DRAIN-SOURCE DIODE CHARACTER	RISTICS					
Continuous Drain-to-Source Diode Forward Current	I <sub>SD</sub>	$V_{GS}$ = -5 V, $T_{J}$ = 25°C	-	_	18	A
Pulsed Drain-to-Source Diode Forward Current (Note 2)	I <sub>SDM</sub>	$V_{GS}$ = -5 V, $T_{J}$ = 25 °C	-	-	132	A
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS}$ = –5 V, $I_{SD}$ = 10 A, $T_J$ = 25 $^\circ C$	-	4	-	V
Reverse Recovery Time	t <sub>RR</sub>	$\label{eq:VGS} \begin{array}{l} V_{GS} = -5/20 \mbox{ V, } I_{SD} = 20 \mbox{ A,} \\ dI_S/dt = 1000 \mbox{ A/}\mu s \end{array}$	-	16	_	ns
Reverse Recovery Charge	Q <sub>RR</sub>		-	62	-	nC
Reverse Recovery Energy	E <sub>REC</sub>		-	5	-	μJ
Peak Reverse Recovery Current	I <sub>RRM</sub>		_	8	_	Α

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



#### TYPICAL CHARACTERISTICS T<sub>J</sub> = 25°C unless otherwise noted



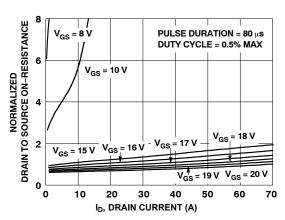
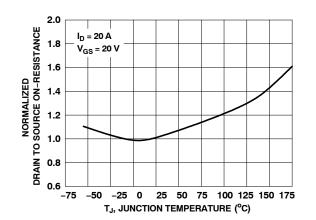
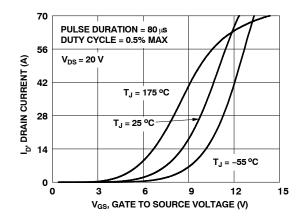


Figure 2. Normalized On–Resistance vs. Drain Current and Gate Voltage









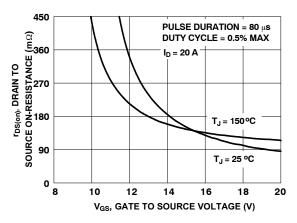


Figure 4. On-Resistance vs. Gate-to-Source Voltage

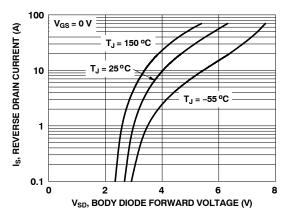


Figure 6. Source-to-Drain Diode Forward Voltage vs. Source Current

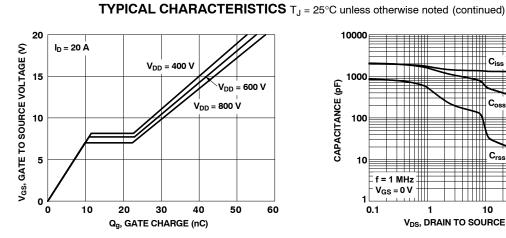


Figure 7. Gate Charge Characteristics

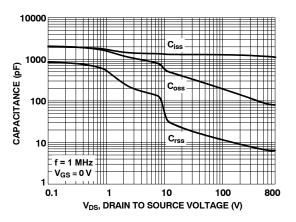


Figure 8. Capacitance vs. Drain-to-Source Voltage

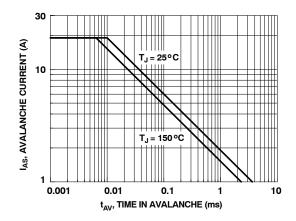
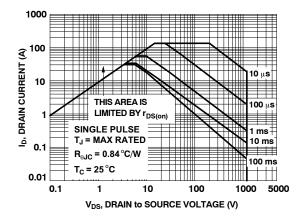
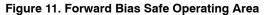


Figure 9. Unclamped Inductive Switching Capability





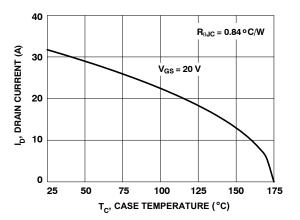


Figure 10. Maximum Continuous Drain **Current vs. Case Temperature** 

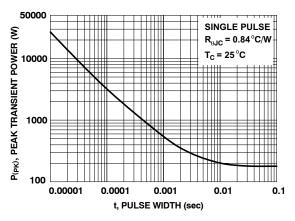


Figure 12. Single Pulse Maximum Power Dissipation

**TYPICAL CHARACTERISTICS**  $T_J = 25^{\circ}C$  unless otherwise noted (continued)

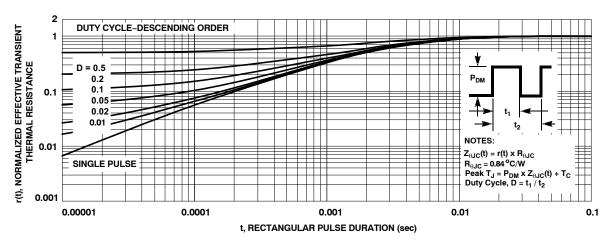
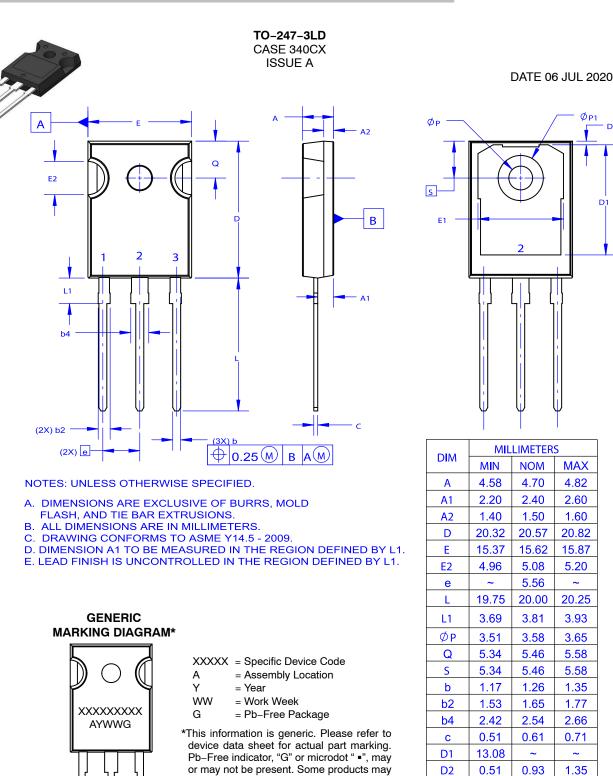


Figure 13. Junction-to-Case Transient Thermal Response Curve



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